

Surface Mount Schottky Barrier Rectifier

FEATURES

- Ideal for automated placement
- Low forward voltage drop
- Low leakage current
- Meets environmental standard MIL-S-19500D
- Moisture sensitivity: level 1, per J-STD-020
- Solder dip 275 °C, 10 s
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC



DO-214AA (SMB)

TYPICAL APPLICATIONS

For use in general purpose rectification of lighting, power supplies, inverters, converters and freewheeling diodes for consumer, automotive and telecommunication.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	2 A
V_{RRM}	20 V to 100 V
I_{FSM}	45A
V_F	0.42V , 0.47V , 0.72V
$T_J \text{ max.}$	125 °C , 150°C

MECHANICAL DATA

Case: DO-214AA, molded epoxy body , Epoxy meets UL 94V-0 flammability rating

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD22B-106

Polarity: Laser Band Denotes Cathode Band

MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)											
PARAMETER	SYMBOL	SL22B	SL23B	SL24B	SL25B	SL26B	SL27B	SL28B	SL29B	SL210B	UNIT
Maximum repetitive peak reverse voltage	V_{RRM}	20	30	40	50	60	70	80	90	100	V
Maximum RMS voltage	V_{RMS}	14	21	28	35	42	49	56	63	70	V
Maximum DC blocking voltage	V_{DC}	20	30	40	50	60	70	80	90	100	V
Maximum average forward rectified current at TL (See Fig.1)	$I_{F(AV)}$	2									A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	45									A
Operating junction temperature range	T_J	- 55 to + 125				- 55 to + 150					°C
Storage temperature range	T_{STG}	- 55 to + 150									°C



SL22B thru SL210B

ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)												
PARAMETER	TEST CONDITIONS	SYMBOL	SL22B	SL23B	SL24B	SL25B	SL26B	SL27B	SL28B	SL29B	SL210B	UNIT
Maximum instantaneous forward voltage	IF=2 A	V _F	0.42			0.47		0.72				V
Maximum DC reverse current at rated DC blocking voltage	TA=25	I _R	0.2			0.15						mA
	TA=100		20			TBD						
Typical junction capacitance	4.0 V, 1 MHz	C _J	175									pF

THERMAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)											
PARAMETER	SYMBOL	SL22B	SL23B	SL24B	SL25B	SL26B	SL27B	SL28B	SL29B	SL210B	UNIT
Maximum thermal resistance	R _{θJA} (1)	72									°C/W
	R _{θJT} (2)	22									

Notes: (1) Thermal resistance from junction to ambient, 0.276 × 0.276" (7.0 × 7.0mm) copper pads to each terminal
 (2) Thermal resistance from junction to terminal, 0.276 × 0.276" (7.0 × 7.0mm) copper pads to each terminal

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

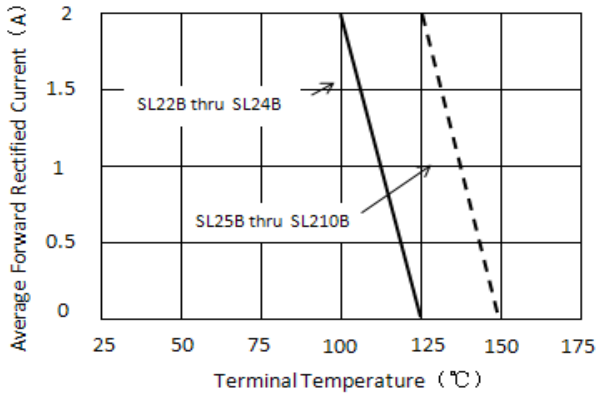


Figure 1. Forward Current Derating Curve

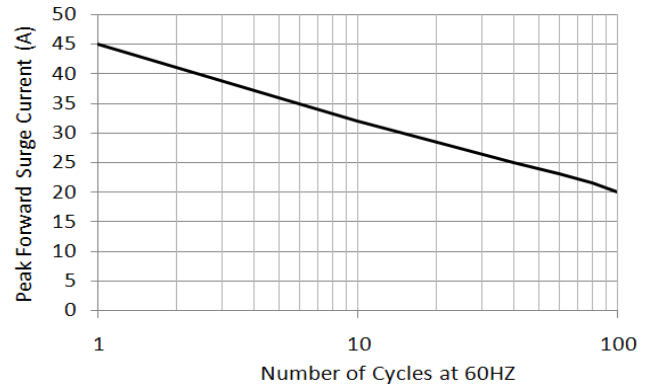


Figure 2. Maximum Non-repetitive Peak Forward Surge Current

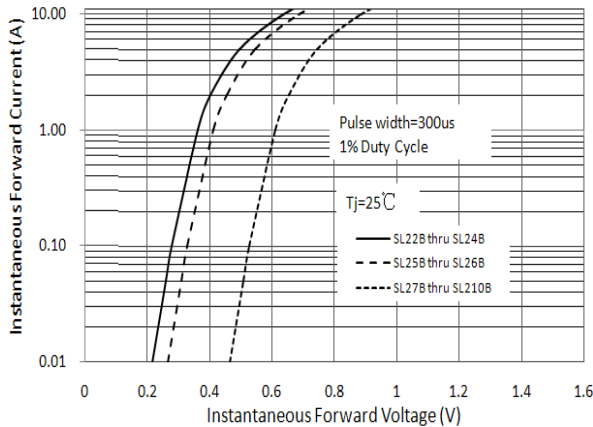


Figure 3. Typical Instantaneous Forward Characteristics

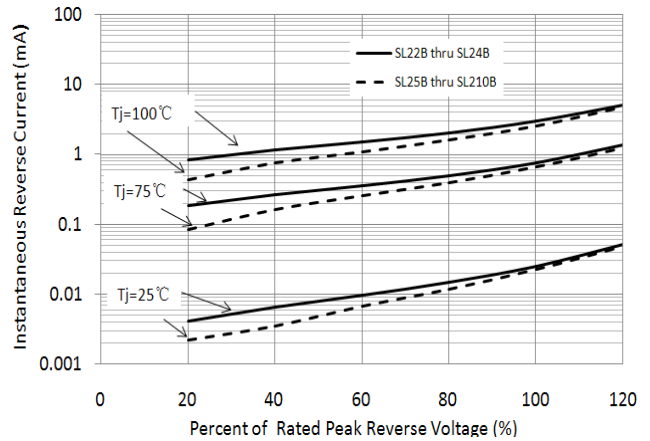


Figure 4. Typical Reverse Characteristics

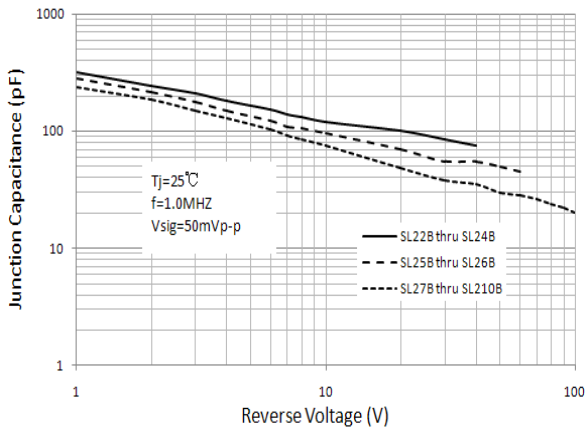


Figure 5. Typical Junction Capacitance

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

